

# Shenzhen Leadtek Electronics Co.,Ltd

## PRODUCT SPECIFICATION

### TFT-LCD MODULE


**Module No: LTK035BFBLM48-V0**

☒ Preliminary Specification

☐ Approval Specification

Designed by	Checked by	Approved by
<i>jona</i>	<i>Terry</i>	<i>lan</i>

### Final Approval by Customer

Approved by	Comment
	<p>Distributed by:</p>  <p><a href="http://www.texim-europe.com">www.texim-europe.com</a></p>

※The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.



1. Document Revision History

Version	Contents	Date	Note
V0	Initial version	2025.4.10	

## 2. General Description

N0	Item	Specification	Unit	Remark
1	LCD Size	TFT"3.97	inch	-
2	Panel Type	TN	-	-
3	Display Resolution	480 x RGB x640	pixel	-
4	Display mode	Normally White /Reflective	-	-
5	Display colors	16.7M	colors.	-
6	Viewing Direction	6, o'clock	-	-
7	LCM Module Size	59.5(H)x 80.72(V) x3.33(T)	mm	Note
8	Active Area	54.84 (H)x 69.12(V)	mm	Note
9	Pixel Pitch	0.108(H) x 0.108(V)	mm	-
10	Weight	TBD	g	-
11	Driver IC	ST7701S	bit	-
12	Light Source	-	-	-
13	Interface	MIPI 2 Lanes	-	-

## 3. Mechanical Drawing



## 4.0 Interface Pin Connection

N0	Symbol	Function
1	GND	Power ground.
2	MIPI_D0+	MIPI_DP0+ are differential data signal line
3	MIPI_D0-	MIPI_DP0- are differential data signal line
4	GND	Power ground.
5	MIPI_D1+	MIPI_DP1+ are differential data signal line
6	MIPI_D1-	MIPI_DP1- are differential data signal line
7	GND	Power ground.
8	MIPI_CLK+	CLOCK Lane positive-end input pin
9	MIPI_CLK-	CLOCK Lane engative-end input pin
10	GND	Power ground.
11	NC	Not connect
12	NC	Not connect
13	GND	Power ground.
14	NC	Not connect
15	NC	Not connect
16	GND	Power ground.
17	GND	Power ground.
18	IOVCC(1.8V)	A supply voltage to the digital circuit. (1.8V)
19	IOVCC(1.8V)	A supply voltage to the digital circuit. (1.8V)
20	TP-VDD	CTP power supply input.(CTP-VDD-3.3V)
21	TP-SDA	CTP I2C data line.(CTP-SDA-1.8V)
22	TP-SCL	CTP I2C clock line.(CTP-SCL-1.8V)
23	TP-GND	CTP ground.
24	RSTB	Reset signal (Low: Active).
25	NC	Not connect
26	TP-INT	CTP interrupt line.
27	GND	Power ground.
28	LED-	LED cathode.



29	LED-	LED cathode.
30	GND	Power ground.
31	NC	Not connect
32	GND	Power ground.
33	GND	Power ground.
34	NC	Not connect
35	LED+	LED anode.
36	LED+	LED anode.
37	GND	Power ground.
38	VCC(3.3V)	A supply voltage to the digital circuit. (3.3V)
39	VCC(3.3V)	A supply voltage to the digital circuit. (3.3V)
40	TP-RESET	CTP reset line.



## 5.0 Absolute Maximum Ratings

### 5.1 Electrical Absolute Rating

#### 5.1.1 TFT LCD Module

Item	Symbol	Min.	Max.	Unit	Note
Power supply voltage	IOVCC	1.65	3.3	V	GND=0
Power supply voltage	VCI	2.65	3.3	V	GND=0
Back-light supply voltage	VF	24	25.4	V	GND=0

Note (1) Stresses above those listed under "Absolute Maximum Rating" may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at indicated in the operational sections(6.1) of this specification.

### 5.2 Environment Absolute Rating

Item	Symbol	Min.	Max.	Unit	Note
Operating Temperature	Topa	-20	70	°C	
Storage Temperature	Tstg	-30	80	°C	

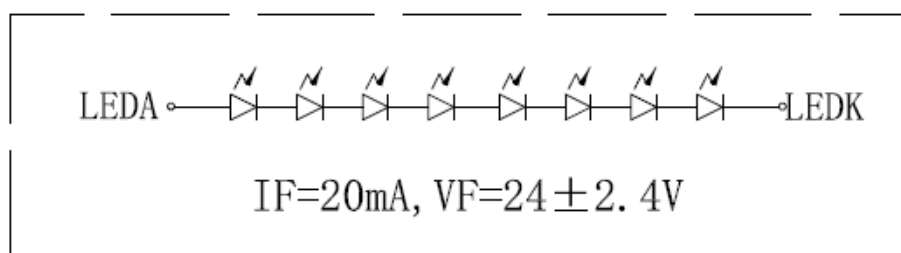
### 5.3 Back-light Unit:

PARAMETER	Sym.	Min.	Typ.	Max.	Unit	Test Condition	Note
LED Current	IF	—	20	—	mA	—	—
LED Voltage	VF	—	24	—	V	—	—
LCM Brightness	Lv	—	135	—	Nits	@CA310	
Life Time		—	30000	—	Hr.	I ≤ 20mA	—
Color	White						

Note (1) Permanent damage may occur to the LCD module if beyond this specification. Functional operation should be restricted to the conditions described under normal operating conditions.

(2) Ta=25±2°C

(3) Test condition: LED Current 20mA



## 6.Timing Characteristics

### Timing POWER ON/OFF SEQUENCE

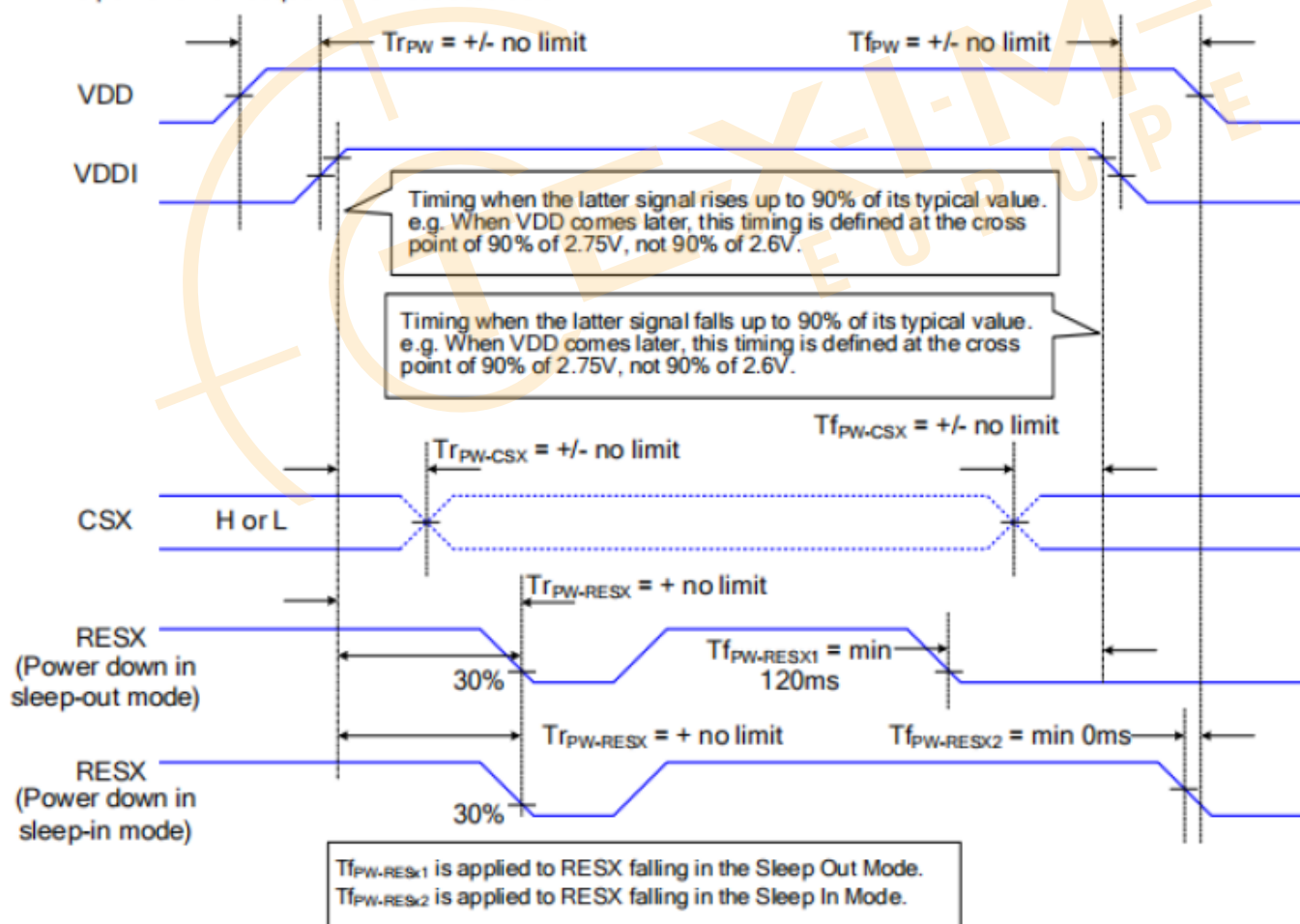
VDDI and VDDA can be applied or powered down in any order. During the Power Off sequence, if the LCD is in the Sleep Out mode, VDDA and VDDI must be powered down with minimum 120msec. If the LCD is in the Sleep In mode, VDDA and VDDI can be powered down with minimum 0msec after the RESX is released.

CSX can be applied at any timing or can be permanently grounded. RESX has high priority over CSX.

Notes:

1. There will be no damage to the ST7701S if the power sequences are not met.
2. There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
3. There will be no abnormal visible effects on the display between the end of Power On Sequence and before receiving the Sleep Out command, and also between receiving the Sleep In command and the Power Off Sequence.
4. If the RESX line is not steadily held by the host during the Power On Sequence as defined in Sections 9.1 and 9.2, then it will be necessary to apply the Hardware Reset (RESX) after the completion of the Host Power On Sequence to ensure correct operations. Otherwise, all the functions are not guaranteed.

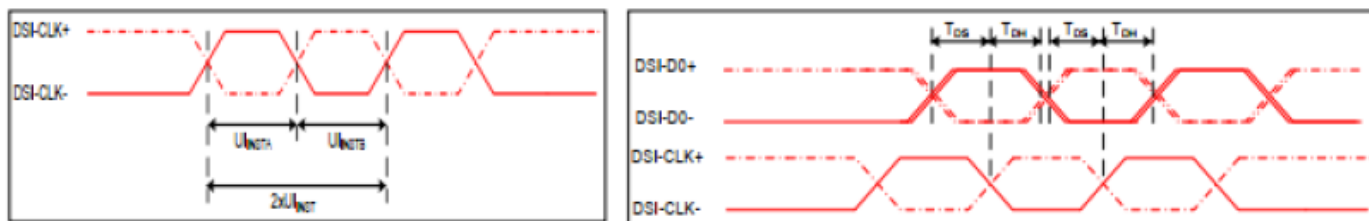
The power on/off sequence is illustrated below





## DSI-MIPI Interface Timing Characteristics of IC

### High Speed Mode



### DSI clock channel timing

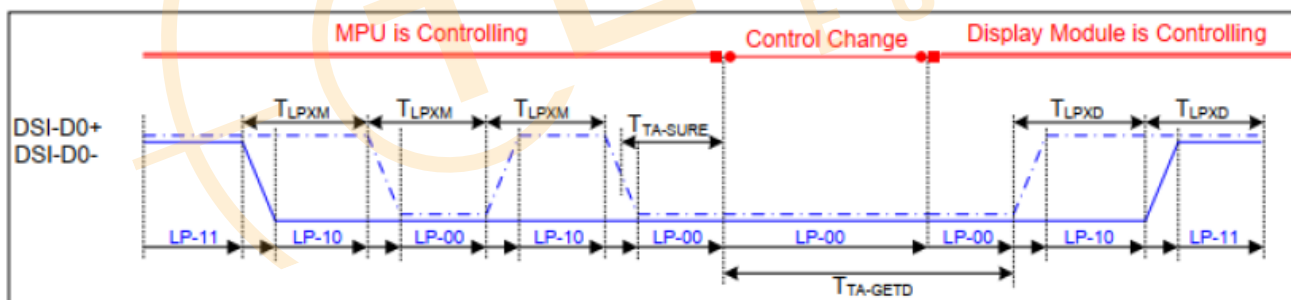
#### Rising and falling time on clock and data channel

$V_{DDI}=1.8, V_{DD}=2.8, A_{GND}=D_{GND}=0V, T_a=25^{\circ}C$

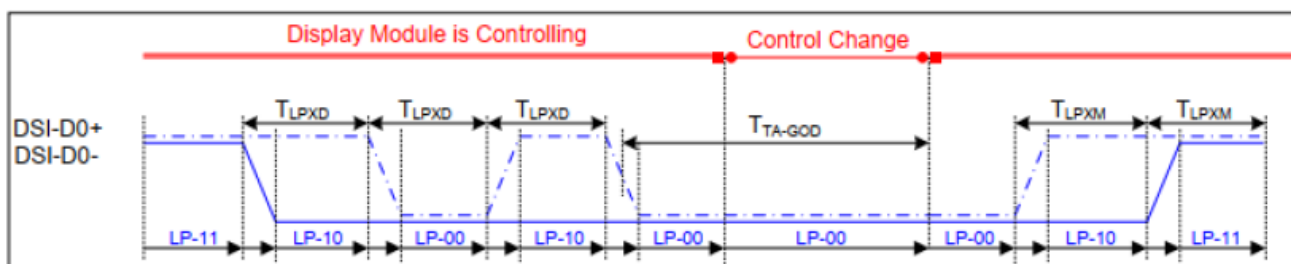
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	$2xU_{INSTA}$	Double UI instantaneous	4	25	ns	
DSI-CLK+/-	$U_{INSTA}$ $U_{INSTB}$	UI instantaneous halves	2	12.5	ns	$UI = U_{INSTA} = U_{INSTB}$
DSI-Dn+/-	tDS	Data to clock setup time	0.15	-	UI	
DSI-Dn+/-	tDH	Data to clock hold time	0.15	-	UI	

### Mipi Interface- High Speed Mode Timing Characteristics

#### Low Power Mode



#### Bus Turnaround (BTA) from display module to MPU Timing



#### Bus Turnaround (BTA) from MPU to display module Timing

$VDDI=1.8, VDD=2.8, AGND=DGND=0V, T_a=25\text{ }^{\circ}\text{C}$ 

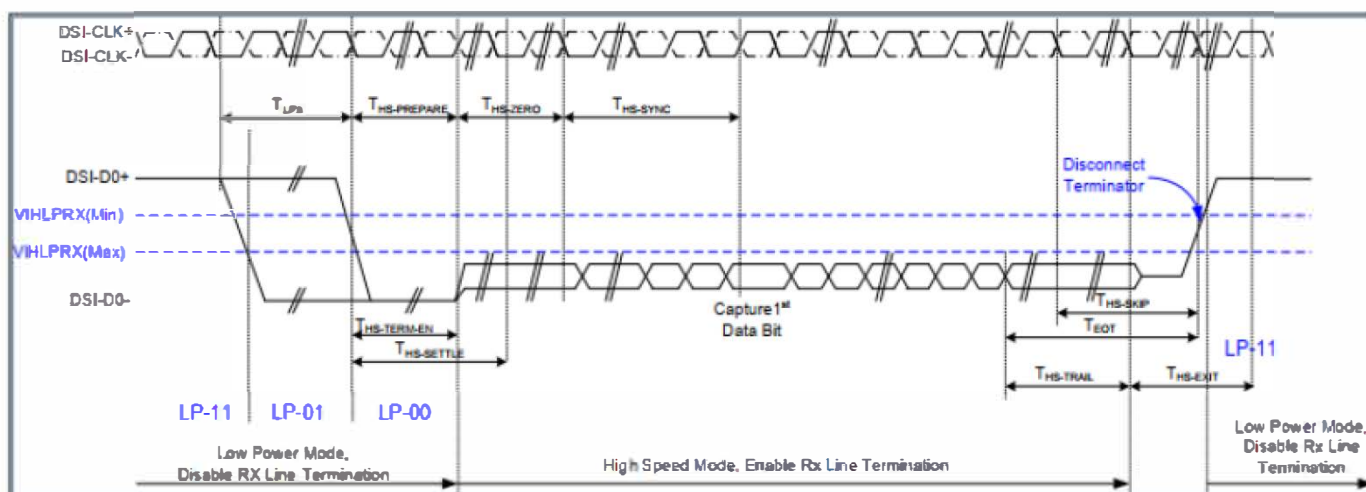
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-D0+/-	TLPXM	Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module	50	75	ns	Input
DSI-D0+/-	TLPXD	Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module	50	75	ns	Output
DSI-D0+/-	TTA-SURED	Time-out before the MPU start driving	$T_{LPXD}$	$2 \times T_{LPXD}$	ns	Output
DSI-D0+/-	TTA-GETD	Time to drive LP-00 by display module	$5 \times T_{LPXD}$		ns	Input
DSI-D0+/-	TTA-GOD	Time to drive LP-00 after turnaround request-MPU	$4 \times T_{LPXD}$		ns	Output

Mipi Interface Low Power Mode Timing Characteristics

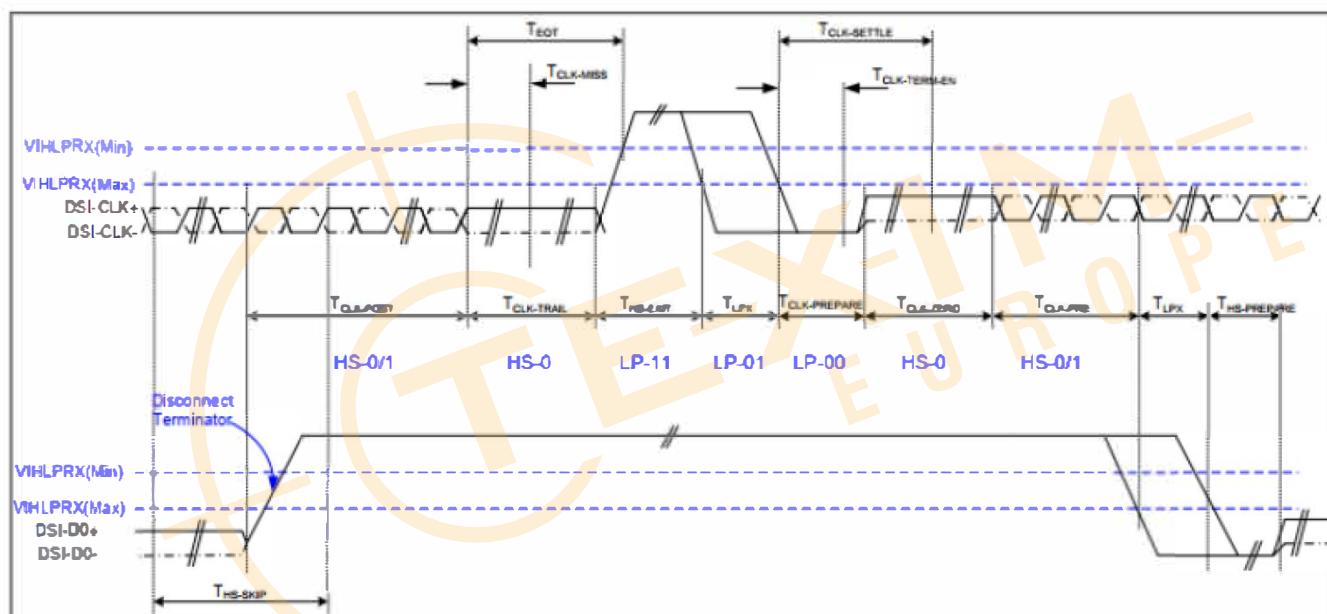


## DSI Bursts Mode

### DSI Bursts Mode



### Data lanes-Low Power Mode to/from High Speed Mode Timing



### Clock lanes- High Speed Mode to/from Low Power Mode Timing

$VDDI=1.3, VDD=2.8, AGND=DGND=0V, T_a=25\text{ }^{\circ}\text{C}$ 

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
Low Power Mode to High Speed Mode Timing						
DSI-Dn+/-	TLPX	Length of any low power state period	50	-	ns	Input
DSI-Dn+/-	THS-PREPARE	Time to drive LP-00 to prepare for HS transmission	40+4 UI	85+6 UI	ns	Input
DSI-Dn+/-	THS-TERM-EN	Time to enable data receiver line termination measured from when Dn crosses VILMAX	-	35+4 UI	ns	Input
DSI-Dn+/-	THS-PREPARE + THS-ZERO	THS-PREPARE + time to drive HS-0 before the sync sequence	140+ 10UI	-	ns	Input
High Speed Mode to Low Power Mode Timing						
DSI-Dn+/-	THS-SKIP	Time-out at display module to ignore transition period of EoT	40	55+4 UI	ns	Input
DSI-Dn+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	-	ns	Input
DSI-Dn+/-	THS-TRAIL	Time to drive flipped differential state after last payload data bit of a HS transmission burst	60+4 UI	-	ns	Input
High Speed Mode to/from Low Power Mode Timing						
DSI-CLK+/-	TCLK-POS	Time that the MPU shall continue sending HS clock after the last associated data lane has transition to LP mode	60+5 2UI	-	ns	Input
DSI-CLK+/-	TCLK-TRAIL	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	-	ns	Input
DSI-CLK+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	-	ns	Input
DSI-CLK+/-	TCLK-PREPARE	Time to drive LP-00 to prepare for HS transmission	38	95	ns	Input
DSI-CLK+/-	TCLK-TERM-EN	Time-out at clock lan display module to enable HS transmission	-	38	ns	Input
DSI-CLK+/-	TCLK-PREPARE + TCLK-ZERO	Minimum lead HS-0 drive period before starting clock	300	-	ns	Input
DSI-CLK+/-	TCLK-PRE	Time that the HS clock shall be driven prior to any associated data lane beginning the transition from LP to HS mode	8UI	-	ns	Input
DSI-CLK+/-	TEOT	Time from start of TCLK-TRAIL period to start of LP-11 state	-	105n s+12 UI	ns	Input

## Reset Description:

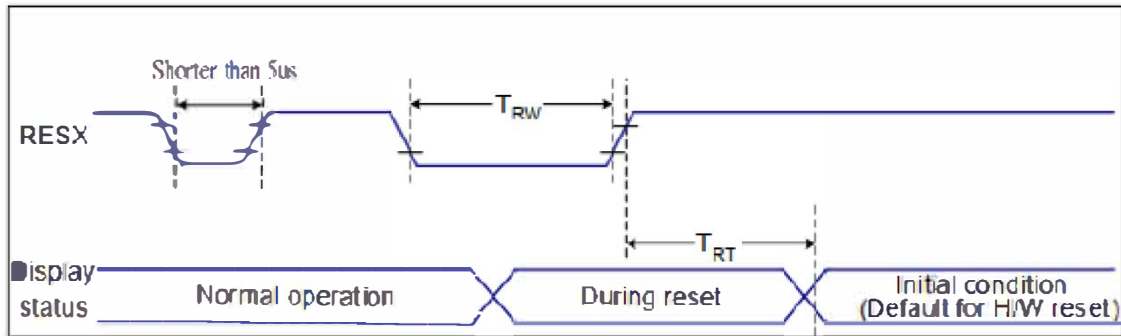


Figure 9 Reset Timing

VDD1=1.8, VDD=2.8, AGND=0V, Ta=25 °C

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Table 9 Reset Timing

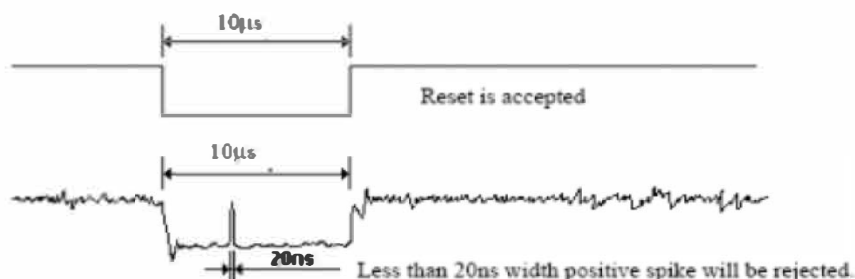
### Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

## 7.0 OPTICAL SPECIFICATIONS

### 7.1 Overview

The test of optical specifications shall be measured at  $25\pm 2^{\circ}\text{C}$  and at the center of the measuring spot on the Display surface shall stay fixed. The backlight should be operating for 30 minutes prior to measurement (Transmittance mode).

Transmittance Mode ( BLU ON ), Reflection Mode( BLU OFF )

Optical should be tested base on BOE's POL and Backlight ( Color Rank : B03 , SuiJing ; Bef\*2 )

Optics should be tested without fingerprint and smudge on panel after peeling off the protective film of polarizer.

Item		B2 SPEC	Remark
Transmittance	Transmittance	Min 1.1%; Typ 1.5%	Test equipment: M1 , Note 4.3
	CR	Min 30:1; Typ 45:1	Test equipment: M3 , Note 4.2
	Color Gamut (NTSC)	Min 15%; Typ 20%	Only CF, C Light, without OC, Note 4.5
	R (x, y)	(0.478, 0.301) $\pm 0.03$	
	G (x, y)	(0.315, 0.454) $\pm 0.03$	
	B (x, y)	(0.180, 0.190) $\pm 0.03$	
	View Angle (12/6/9/3点)	TBD	Test equipment: M1 source pad down, CR>10 Note 4.1
	人眼观看角度	6点	Source Pad Down
	Response Time (25°C)	Max 30ms	Test equipment: M1 Tr+Tf, W90%/B10%. Note 4.4
Reflection	Reflection (SCI)	Min 8%; Typ 9.5%	Test equipment: M2 Note 4.3
	CR	Min 6; Typ 8	Test equipment: M2 Note 4.2
	Color Gamut (NTSC)	Min 13%; Typ 17%	NTSC Test equipment: M2 Note 4.5
	W (x, y)	(0.316, 0.370) $\pm 0.03$	
	View Angle (12/6/9/3点)	TBD	Test equipment: M1 source pad down, CR>2 Note 4.1



## Measuring Condition:

Transmittance Mode ( Blu on ), Reflection Mode( Blu off );  
Dark room (ambient luminance  $\leq 1\text{lux}$ ); Ambient temperature:  $25\pm 2^{\circ}\text{C}$

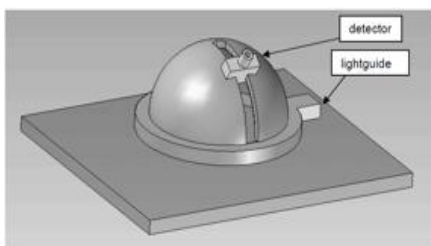
**Measuring Point:** Center of the Active area (one point) unless otherwise specified

## Measuring Equipment:

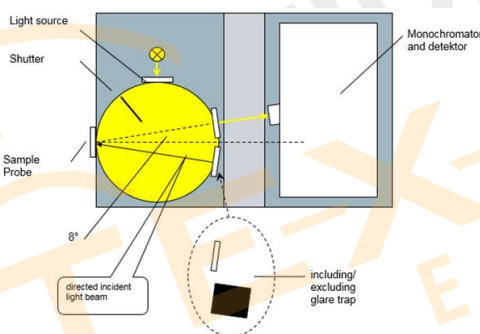
### <1> Reflective Mode measurement system

Backlight is off, test point AA center

M1: Measure equipment: DMS903



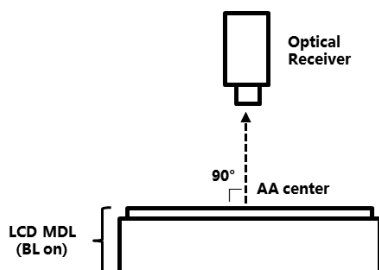
M2: Measure equipment: CM700D (8°, D65)



### <2> Transmissive mode measurement system

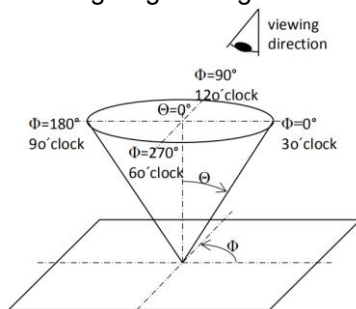
Backlight is on , test point AA center

M3: Measure equipment: EYE2-400



4.1. Specifications are based on module testing. Transmittance/Reflection viewing angle is the angle at which the contrast ratio is greater than 10 / 2. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface. Spec. will be updated according to measured values. Human viewing angle is 8'clock in trans mode (source pad 6'clock).

<Figure 4.1. Viewing Angle Range Is Defined As Follows>

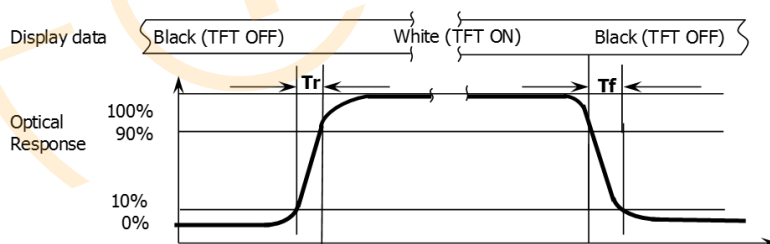


4.2. Specifications are based on module testing. Contrast measurements shall be made at viewing angle of  $\theta = 0^\circ$  and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. Contrast Ratio (CR) is defined mathematically.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

4.3. Specifications are based on module testing. Center transmittance and reflection of white is defined as the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. Trans based on BOE背光 (Color Rank: B03, 穗晶; Bef\*2) .

4.4. Specifications are based on module testing. Response time (black to white):  $Tr + Tf$  Black(10%) to White(90%). As shown in figure below, the time needed for the transmittance to change from 10% to 90% is  $Tr$ , and 90% to 10% is  $Tf$ .



4.5. The color coordinates and Color Gamut of Transmittance mode specified in Table 4. shall be measured at the center of the color filter glass with C - light source. The color coordinates of Reflection mode specified in Table 4. shall be measured at the center of the panel with D65 light. Color Gamut of Reflection Mode should be tested with LCM and calculated by RGB's x and y as below:



## 8. Reliability test items

No.	Test Item	Test Condition	Notes
1	High Temp. Storage	+80°C / 48H	1. Functional test isOK. Missing Segment,short, unclear segment non-display,display abnormally and liquid crystal leakare un-allowed. 2. No low temperature bubbles,end seal loose andfall, frame rainbow.
2	Low Temp. Storage	-30°C / 48H	
3	High Tempe. Operating	+70°C / 48H	
4	Low Tempe. Operating	-20°C / 48H	
5	High Temperature /Humidity storage	50°C x 90%RH /48H	
6	Thermal and cold shock	Static state, -20°C (30min) ~60°C (30min), 50 cycles	
7	ESD test	±2KV,Human Body Mode, 150pF/330Ω; ±4KV, Air Mode, 150pF/330Ω;	

Note: All tests above are practiced at module type.

There is no display function NG issue occurred, All the cosmetic specification is judged before the reliability stress.

## 9.0 General Precaution

### 9.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life-threatening or otherwise catastrophic.

### 9.2 Assembly Precaytton

- 1、 Please use the mounting hole on the module side in installing and do not bending or wrenching LCD in assembling. And please do not drop, bend or twist LCD module in handling.
- 2、 Please design display housing in accordance with the following guide lines.
- 3、 Housing case must be destined carefully so as not to put stresses on LCD all sides and not to wrench module. The stresses may cause non-uniformity even if there is no non-uniformity statically.
- 4、 Keep sufficient clearance between LCD module back surface and housing when the LCD module is mounted. The clearance in the design is recommended taking into account the tolerance of LCD module thickness and mounting structure height on the housing.
- 5、 Please do not push or scratch LCD panel surface with any-thing hard. And do not soil LCD panel surface by touching with bare hands. ( Polarizer film, surface of LCD panel is easy to be flawed.)
- 6、 Please do not press any parts on the rear side such as source IC, gate IC, and FPC during handling LCD module. If pressing rear part is unavoidable, handle the LCD module with care not to damage them.
- 7、 Please wipe out LCD panel surface with absorbent cotton or soft cloth in case of it being soiled.
- 8、 Please wipe out drops of adhesives like saliva and water on LCD panel surface immediately. They might damage to cause panel surface variation and color change. 11.2.7 Please do not take a LCD module to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.

### 9.3 Disassembling or Modification

Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. Leadtek does not warrant the module, if customers disassemble or modify the module.

### 9.4 Breakage of LCD Panel

- 1、 If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin.
- 2、 If liquid crystal contacts mouth or eyes, rinse out with water immediately.
- 3、 If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.
- 4、 Handle carefully with chips of glass that may cause injury, when the glass is broken.

## 9.5 Absolute Maximum Ratings and Power Protection Circuit

- 1、 Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts' parameters, environmental temperature, etc., otherwise LCD module may be damaged.
- 2、 Please do not leave LCD module in the environment of high humidity and high temperature for a long time.
- 3、 It's recommended employing protection circuit for power supply.

### 11.6 Operation

- 1 、 Do not touch, push or rub the polarizer with anything harder than HB pencil lead. Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.
- 2、 When the surface is dusty, please wipe gently with absorbent cotton or other soft material.
- 3 、 Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.
- 4 、 When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzine or other adequate solvent.

## 9.6 Static Electricity

- 1 、 Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.
- 2、 Because LCD module uses CMOS-IC on TFT-LCD panel, it is very weak to electrostatic discharge. Please be careful with electrostatic discharge.
- 3 、 Persons who handle the module should be grounded through adequate methods.

## 9.7 Disposal

When disposing LCD module, obey the local environmental regulations.

## 9.8 OTHERS

- 1 、 A strong incident light into LCD panel might cause display characteristics' changing inferior because of polarizer film, color filter, and other materials becoming inferior. Please do not expose LCD module direct sunlight land strong UV rays.
- 2、 Please pay attention to a panel side of LCD module not to contact with other materials in preserving it alone.
- 3、 For the packaging box, please pay attention to the followings:
- 4、 Packaging box and inner case for LCD are designed to protect the LCDs from the damage or scratching during transportation. Please do not open except picking LCDs up from the box.
- 5、 Please do not pile them up more than 6 boxes. (They are not designed so.) And please do not turn over.
- 6、 Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.
- 7、 Packing box and inner case for LCDs are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)

## 10.0 Packing form-TBD

**深圳市丽台电子有限公司****Shenzhen Leadtek Electronics Co.,Ltd**

# Incoming Inspection Standard

## 品质允收标准

Model N0. /产品型号: Applicable to Leadtek Touch Display ScreenUpdated Date /生效日期: 2025.04.01Version / 版本号: V0

Record of Revision /修订履历.

Version /版本号	Revision Record /修订内容	Reviser /修订人	Revision Date /修订日期
V0	首发 / Initial release	Green	2025.04.01

## 1、Scope of application /适用范围.

适用于丽台电子触摸显示屏/ Applicable to Leadtek Touch Display Screen.

## 2、Inspection conditions and environment / 检验条件与环境.

### 2.1、Inspection Conditions / 检验条件:

2.1.1、Inspection Distance / 检测距离: 35cm  $\pm$ 5cm.

2.1.2、Inspection time /检验时间: Displays performance test /功能测试: 2~3S /Image,

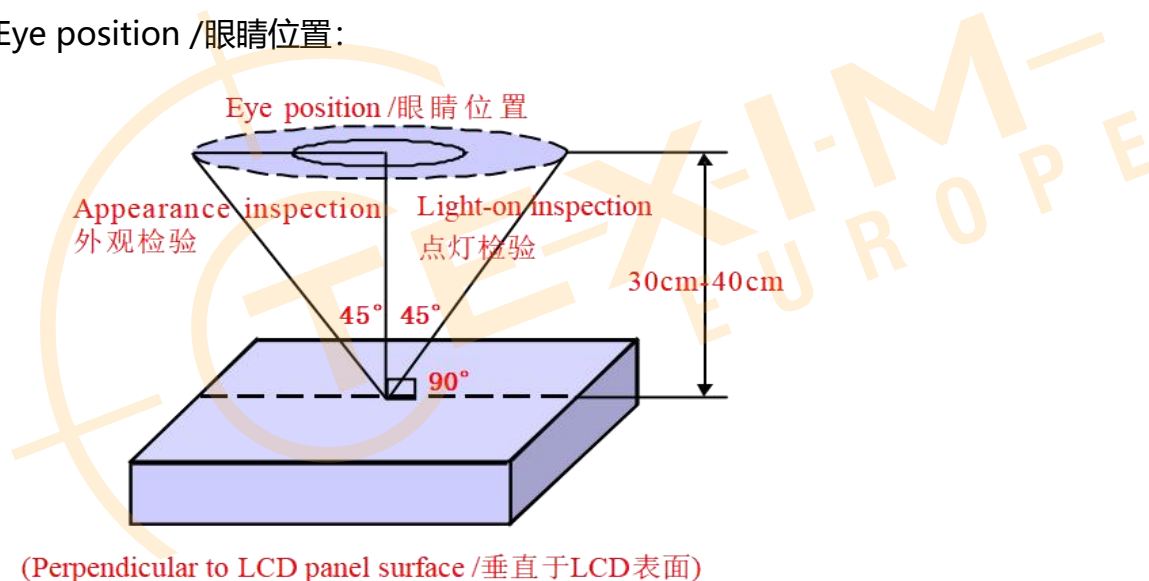
Appearance Inspection / 外观检验: 8~10S.

2.1.3、Inspection the viewing angle /检验视角:

Display Inspection Angle /显示检验角度:  $\pm 45^\circ$ .

Appearance Inspection Angle /外观检验角度:  $\pm 45^\circ$ .

Eye position /眼睛位置:



### 2.2、Inspection environment /检验环境:

Temperature / 温度		25 $\pm$ 5 $^\circ$ C
Humidity / 湿度		55 $\pm$ 5%RH
Brightness	Appearance Inspection / 外观检验	800~1000 Lux
亮度	Display Inspection / 功能检验	200~300 Lux

### 2.3、Sampling conditions / 抽样方式.

Sampling Plan /抽样计划		GB/T 2828.1- 2003
		Batch single sampling/批量单次抽样
		General inspection level: II/一般检验水平: 二级
AQL	Major Defect /主要缺陷	0.25
	Minor Defect /次要缺陷	0.65

### 3、Terms and definitions /术语和定义.

#### 3.1、Defect classification / 缺陷分类:

3.1.1、Major defects /主要缺陷: Defects that cause the product to fail or reduce the usability of the product / 引起产品功能失效和减少产品的有效使用与操作的缺陷.

3.1.2、Minor defects / 次要缺陷: Defects that do not affect the functionality and effective use and operation of the product / 不影响产品功能和有效使用与操作的缺陷.

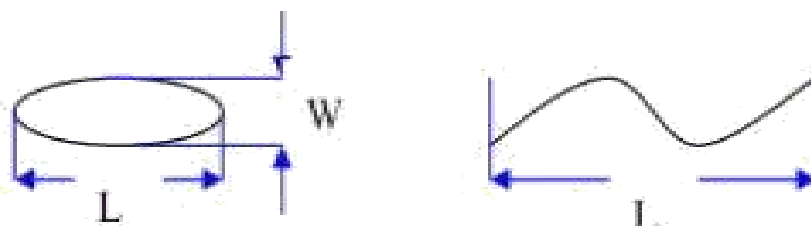
#### 3.2、Point defects / 点状缺陷:

The size of a punctate defect is defined by the diameter D, and the average diameter of the defect is  $D=1/2(W+L)$  / 点状缺陷由直径 D 定义大小, 缺陷的平均直径  $D=1/2(W+L)$ .

#### 3.3、line defects / 线状缺陷:

When defect size  $L \geq 2W$ , the defect count as liner type defect. Size of linear defect is defined by length (L) and the maximum width (W)

当缺陷尺寸  $L \geq 2W$  时, 被视为线状缺陷, 线状缺陷是由长度 (L) 和最大宽度 (W) 定义的.



### 3.4、LCD sub-pixels / LCD 子像素点:

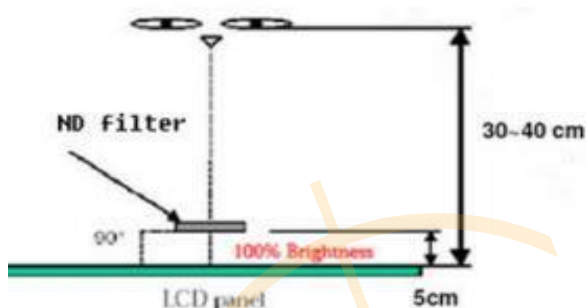
The sub-pixel defect area is greater than 50% of the LCD sub-pixel area, and is visible through ND5% masking

子像素点缺陷面积大于 50% LCD 子像素面积, 且透过 ND5%遮盖是可见的.

### 3.5、ND card test method / ND 卡检验方法:

Hold the ND card about 5cm above the display area, with your eyes 30-40cm away from the panel, and observe for 2~3 seconds

在显示区域上方大约 5cm 处握住 ND 卡, 眼睛距离面板 30-40cm, 观察 2~3 秒.



3.6、Surface substances that can be cleaned are not considered defects (e.g. finger prints on the protective film, dust particles)

可以被清洁干净的表面物质不视为缺陷 (如保护膜上的手指印, 尘粒) .

3.7、Defects that can be covered by the material and are not visible to the eye, and do not affect the function and use are not considered defects

能被物料覆盖目视不可见, 且不影响功能与使用的缺陷不视为缺陷.

3.8、AA shows that damage to the glass outside the area does not affect the effective line and does not expand the loss is acceptable

AA 显示区域以外的玻璃损伤, 不影响有效线路和不会在扩大损失的是可以接受的.

3.9、Issues not specified or defined in this document shall be dealt with through friendly negotiation between the parties / 本文件中未规定或定义的问题, 双方友好协商处理.



#### 4.0、Inspection standards /检验标准:

##### 4.1、Structural size standards / 结构尺寸标准:

Measurement items /测量项目		Specification /规格	Remark /备注
Name/名称	Unit /单位	Tolerance /公差	
Outside dimension: Length 尺寸: 长	mm /毫米	0.10mm~0.3mm	Please refer to the product specification for detailed dimensions and tolerances 详细的尺寸规格和公差请参考产品规格书
Outside dimension: Width 尺寸: 宽	mm /毫米	0.10mm~0.3mm	
Outside dimension: Thickness 尺寸: 厚	mm /毫米	0.20mm~0.50mm	

##### 4.2、Appearance Inspection standards:

( D : diameter, W : width, L : length, N : quantity, DS : spacing )

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
LCD	ITO	Full size 全尺寸	ITO can't open circuit, short circuit, ITO notch cannot exceed 70% of width. ITO 不能有开路和短路, ITO 缺口不能超过宽度的70%.	MA	
	Corners broken 崩边/崩角	Full size 全尺寸	1、It cannot affect the appearance of valid routes and functions; 不能影响有效线路和功能外观.	MA	
			2、There must be no extensible rips 不能有可延伸性裂纹.	MA	
Silicone 硅胶	Silicone coating 硅胶涂布	Full size 全尺寸	1、The height cannot exceed the LCD CF surface / 高度不能超过 LCD CF 面.		MI
			2、No overflow and lack of glue / 不能溢胶和缺胶.		MI
			3、Silicone cannot cover POL and FPC/ 硅胶不能覆盖到 POL 和 FPC.		MI



Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
PCBA  FPC  Connector 连接器	Appearance 表面外观	Full size 全尺寸	1.FPC is not allowed to have drape/bubble/fold / 不允许有披锋/气泡/褶皱.		MI
			2.Surface scratches do not allow copper leakage / 表面划伤不允许出现漏铜.	MA	
			3.Cracking is not allowed / 不允许破裂.	MA	
			4.Gold finger oxidation is not allowed 不允许金手指氧化.	MA	
			5.Chromatic aberration is not allowed 不允许出现色差.	MA	
	Components 元器件	Full size 全尺寸	1. Damage, missing parts, and incorrect models are not allowed 不允许损伤、缺件、型号错误.	MA	
			2.Components need to be insulated with high temperature adhesive (unless not required by the drawings) / 元器件需要有高温胶绝缘保护 (除非图纸无要求) .		MI
	Weld 焊接	Full size 全尺寸	1. False soldering, virtual soldering, and tinning are not allowed 不允许假焊、虚焊、连锡.	MA	
			2. No solder bead residue is allowed 不允许有锡珠残留.		MI
			3.The pads need to be glued with high temperature (unless not required by the drawings) / 焊盘需贴高温胶 (除非图纸无要求) .		MI
POL 偏光片	Scratches 划伤	Under 6 inches 6寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) .		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
POL 偏光片	Bubbles	Under 6 inches 6 寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		More than 6 inches 6 寸以上	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
	Bubbles around the edges 边缘气泡	Full size 全尺寸	1.Within 1/2BM of the display area, it is not allowed 显示区往外 1/2BM 区域内, 不允许. 2.The display area is 1/2 outside the BM area, and it is not controlled 显示区往外 1/2BM 区域以外, 不管控.		MI
	Point defects Embossing	Under 6 inches 6 寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		6~10.0 inches 6 寸~10.0 寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
		More than 10 inches 10 寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .		MI
	Dirty 脏污	Full size 全尺寸	Dirt, finger prints, etc. are not allowed 不允许有脏污、手指印等.		MI
	Warping 起翘	Full size 全尺寸	Not allowed 不允许.		MI
	Paste offset 贴附偏位	Full size 全尺寸	It is not allowed to exceed the patch tolerance required by the drawing; After TP lamination, it is not allowed to leak the edges of the polarizer 不允许超出图纸要求的贴片公差; 在 TP 贴合后不允许漏偏光片边缘.		MI
	Angle mistake 角度错误	Full size 全尺寸	Not allowed 不允许.	MA	
	Mixture 混料	Full size 全尺寸	Not allowed 不允许.	MA	

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
TP	Scratches 划伤	Under 6 inches 6 寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2 ; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI
		6~10.0 inches 6 寸~10.0 寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI
		More than 10 inches 10 寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI
	Black dots white dots 黑点/白点	Under 6 inches 6 寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		6~10.0 inches 6 寸~10.0 寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
		More than 10 inches 10 寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .		MI
	OCA Bubbles 气泡	Full size 全尺寸	Not allowed 不允许.		MI
	Corners broken 崩边/崩角	Full size 全尺寸	1.Product front /产品正面: Edge and corner chipping is not allowed / 崩角、崩边不允许 2.Product back /产品背面: X≤ 0.5 , Y≤0.5, Z≤1/2T; N≤4; DS≥10mm.	MA	
	Silk screen 丝印	Full size 全尺寸	The silk screen is clear, complete and correct 丝印清晰、完整、内容正确.		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
TP	Dirty 脏污	Full size 全尺寸	Uncleanable dirt, Not allowable. 不可擦拭的脏污, 不允许.		MI
	Broken 破损	Full size 全尺寸	Not allowable. 不允许.		MI
	Ink color aberration 油墨色差	Full size 全尺寸	$\Delta E > 1$ , Not allowable (不允许) .		MI
	Cover pinholes 针孔	Full size 全尺寸	1.D $\leq$ 0.20mm, N $\leq$ 2, DS $\geq$ 10mm, allowable 2.D > 0.20mm, intensive pinholes (密集型针孔) , Not allowable (不允许) .		MI
	Paint off 掉漆	Full size 全尺寸	Touch-up on the back of the cover is allowed, and the touch-up area cannot exceed 2.0mm in diameter / 允许在盖板背面补漆, 补漆面积不 能超过直径 2.0mm.		MI
BL 背光	Backlight separation 背光分离	Full size 全尺寸	Not allowable 不允许.		MI
	Deformed 变形	Full size 全尺寸	Measured using a plug gauge, If the deformation exceeds 0.3mm, NG is judged 使用塞规测量, 形变超过 0.3mm, 判定 NG.		MI
	Iron frame Oxidation /abscission 铁框氧化/脱落	Full size 全尺寸	Not allowable 不允许.		MI
	Dirt/adhesive residue/solder beads 脏污/残胶/锡珠	Full size 全尺寸	Not allowable 不允许.		MI
	Inkjet/barcode/ QR code 喷码/条码/二维 码	Full size 全尺寸	The inkjet code is clear and complete, the barcode and QR code can be scanned normally, and the content and format meet the requirement / 喷码清晰完整、条码和二维码 可正常扫描, 内容和格式与要求相符.		MI
	Auxiliary materials 辅料	Full size 全尺寸	Accessories (vinyl, double-sided tape, insulating glue, etc.) are not allowed to be missed, misguided, defective, etc 辅料 (黑胶、双面胶、绝缘胶等) 不允许有漏贴、 贴偏、残缺等.		MI

### 4.3、Functional inspection standards:

( D : diameter, W : width, L : length, N : quantity, DS : spacing )

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
Display Screen 模组	Light leakage / Mura 漏光/ Mura	Full size 全尺寸	1.Use ND5% filter masking, visual invisibility is OK 使用 ND5%遮盖, 目视不可见即为 OK. 2.If necessary, sign off on the sample 必要时, 签限定样.		MI
	Brightness uniformity 亮度均匀性	Full size 全尺寸	Brightness uniformity < 85.0%, Not allowable 亮度均匀性 < 85.0%, 不允许.	MA	
	LCD bright spots/dark spots 玻璃亮点/暗点	Under 6 inches 6 寸以下	1.D≤0.10mm, Ignore (忽略) . 2.0.10mm < D≤0.20mm; N≤2; DS≥10mm. 3.D > 0.20mm, Not allowable (不允许) .		MI
		6~10.0 inches 6 寸~10.0 寸	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤3; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		More than 10 inches 10 寸以上	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤4; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
	Backlight black dots/white dots 背光黑点/白点	Under 6 inches 6 寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		6~10.0 inches 6 寸~10.0 寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
		More than 10 inches 10 寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .		MI
	Linear foreign bodies 线状异物	Under 6 inches 6 寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) .		MI
		6~10.0 inches 6 寸~10.0 寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) .		MI
		More than 10 inches 10 寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) .		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
Display Screen 模组	White/Black print 白印/黑印	Full size 全尺寸	Use ND5% filter masking, visual invisibility is OK 使用 ND5%遮盖, 目视不可见即为 OK.		MI
	Interference pattern/Newtonian pattern 干涉纹/牛顿纹	Full size 全尺寸	Not allowable 不允许.		MI
	Membranes displacement 膜材移位	Full size 全尺寸	Not allowable 不允许.		MI
	Color blocks 色斑	Full size 全尺寸	Use ND5% filter masking, visual invisibility is OK /使用 ND5%遮盖, 目视不可见即为 OK.		MI
	Display abnormal 画异	Full size 全尺寸	Not allowable 不允许.	MA	
	No display 无显示	Full size 全尺寸	Not allowable 不允许.	MA	
	Line/Missing Drawing 线条/缺画	Full size 全尺寸	Not allowable 不允许.	MA	
	Splash screen 闪屏	Full size 全尺寸	Not allowable 不允许.	MA	
	LCD grid LCD 网格	Full size 全尺寸	Not allowable 不允许.	MA	
	Afterimage 残影	Full size 全尺寸	Not allowable 不允许.	MA	
	Wrong viewing angle 可视角错误	Full size 全尺寸	Not allowable 不允许.	MA	
TP	No touch 无触摸	Full size 全尺寸	Not allowable 不允许.	MA	
	Touch the jump point 触摸跳点	Full size 全尺寸	Not allowable 不允许.	MA	
	Touch not sensitive 触摸不灵敏	Full size 全尺寸	Not allowable 不允许.	MA	

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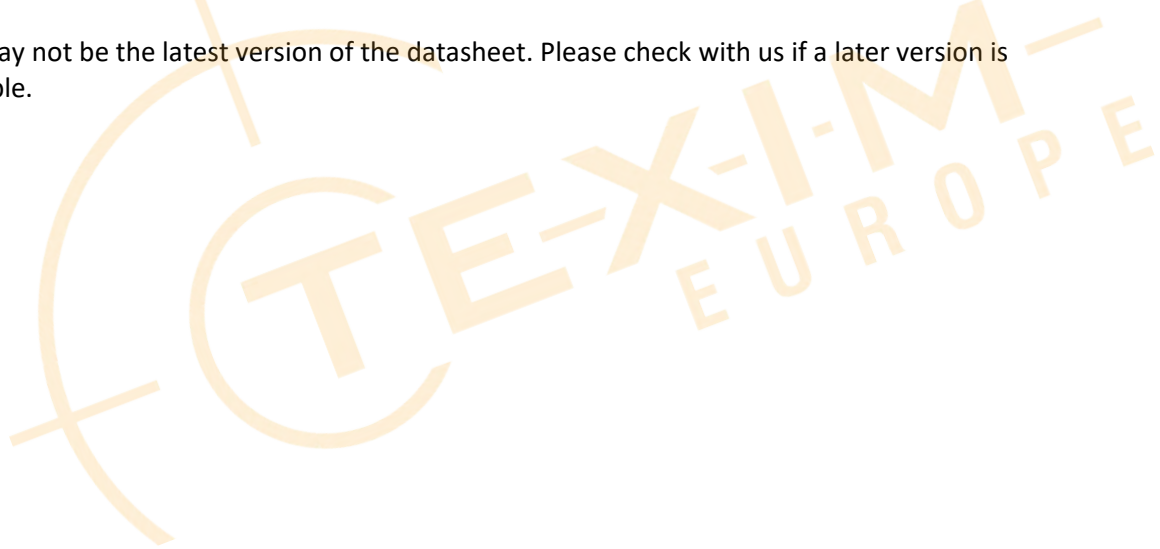
It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.

Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time.

All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts.

Please contact us if you have any questions about the contents of the datasheet.

This may not be the latest version of the datasheet. Please check with us if a later version is available.







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